## Amendments to the Specification

Please replace paragraph [00068] with the following amended paragraph:

[00068] Further details regarding the fabrication of diode arrays using conductive polymer technology are set forth in further detail in U.S. Patent Application Ser. No. 10/720,421 10/xxx,xxx (Attorney docket number ELG056 US1), which is expressly incorporated herein by reference.

Please replace paragraph [00081] with the following amended paragraph:

[00081] Further details regarding the fabrication of transistor arrays using conductive polymer technology are set forth in further detail in U.S. Patent Application Ser. No. 10/720,421 10/xxx,xxx (Attorney docket number ELG056 US1), which is expressly incorporated herein by reference.